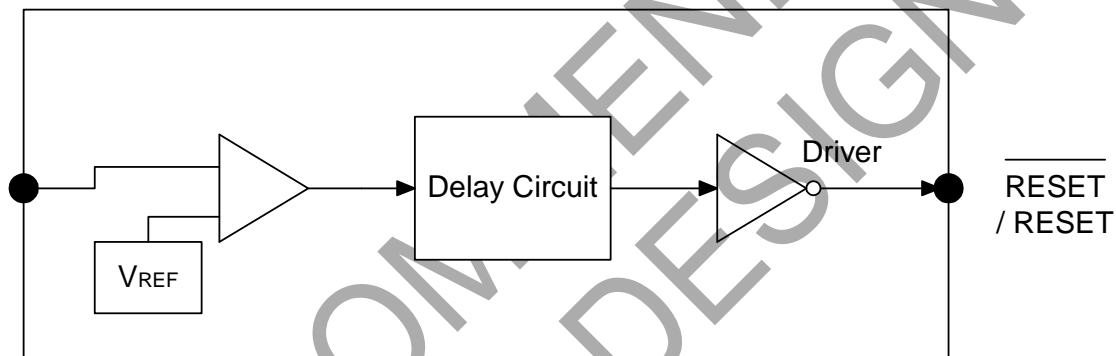


## Pin Descriptions

Pin Name	Description
GND	Ground
$\overline{\text{RESET}}$ (RESET)	Reset Output Pin L: for APX809 H: for APX810
V <sub>CC</sub>	Operating Voltage Input

## Functional Block Diagram



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	5	kV
ESD MM	Machine Model ESD Protection	500	V
V <sub>CC</sub>	Supply Voltage	-0.3 to +6.0	V
V <sub>RESET</sub>	RESET, $\overline{\text{RESET}}$ (Push-pull)	-0.3 to (V <sub>CC</sub> + 0.3)	V
I <sub>CC</sub>	Input Current, V <sub>CC</sub>	20	mA
I <sub>O</sub>	Output Current, RESET, $\overline{\text{RESET}}$	20	mA
P <sub>D</sub>	Continuous Power Dissipation (T <sub>A</sub> = +70°C), De-rate 4mW/°C above +70°C	400	mW
T <sub>OP</sub>	Operating Junction Temperature Range	-40 to +105	°C
T <sub>ST</sub>	Storage Temperature Range	-65 to +150	°C

## Recommended Operating Conditions

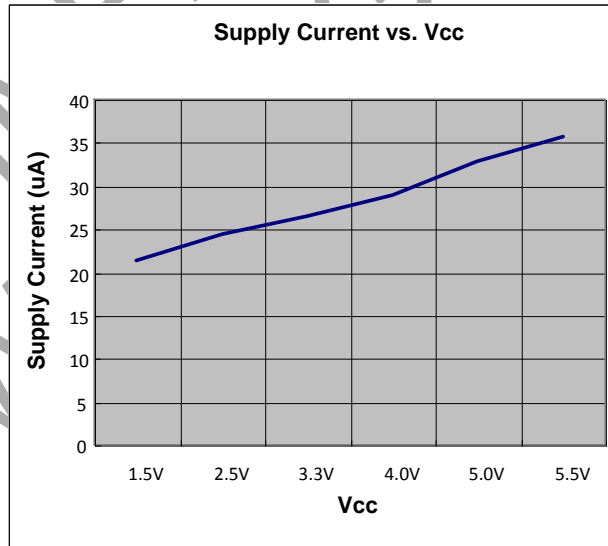
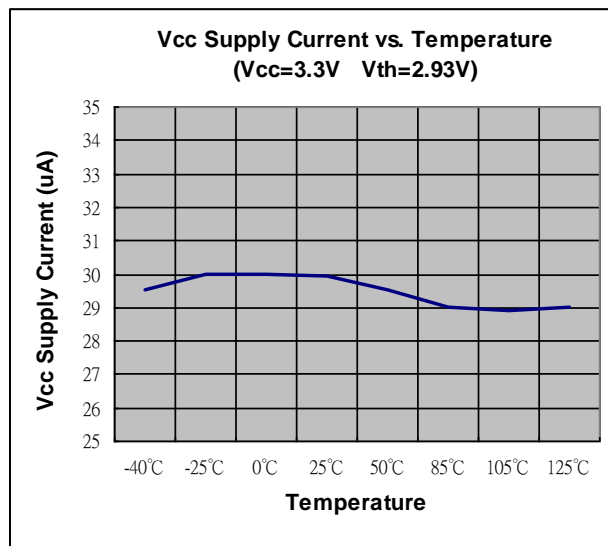
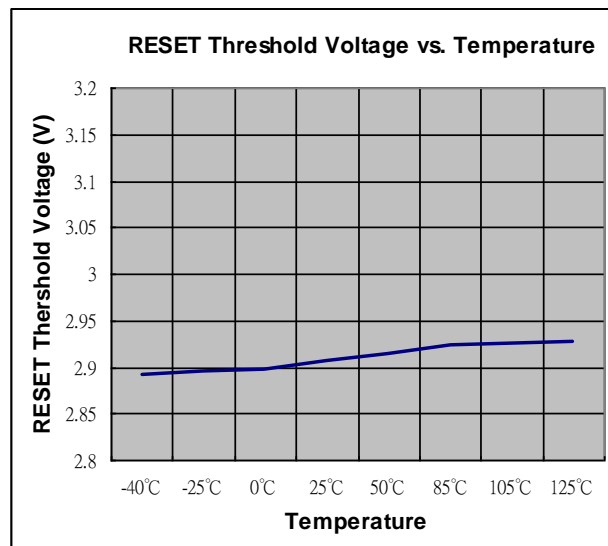
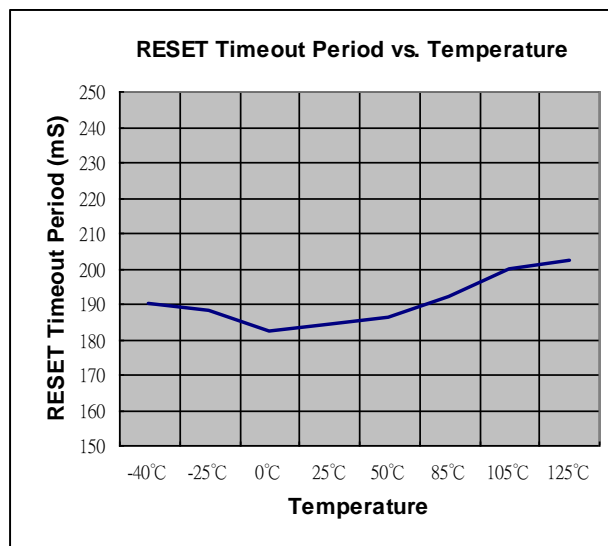
Symbol	Parameter	Min	Max	Unit
$V_{CC}$	Supply Voltage	1.1	5.5	V
$V_{IN}$	Input Voltage	0	$(V_{CC} + 0.3)$	V
$T_A$	Operating Ambient Temperature Range	-40	+85	°C
$t_R$	$V_{CC}$ Rising Time ( $V_{CC} = 0$ to $V_T$ )	—	100	μs

## Electrical Characteristics (@ $T_A = -40$ to $+85^\circ\text{C}$ , unless otherwise note. Typical values are at $T_A = +25^\circ\text{C}$ .)

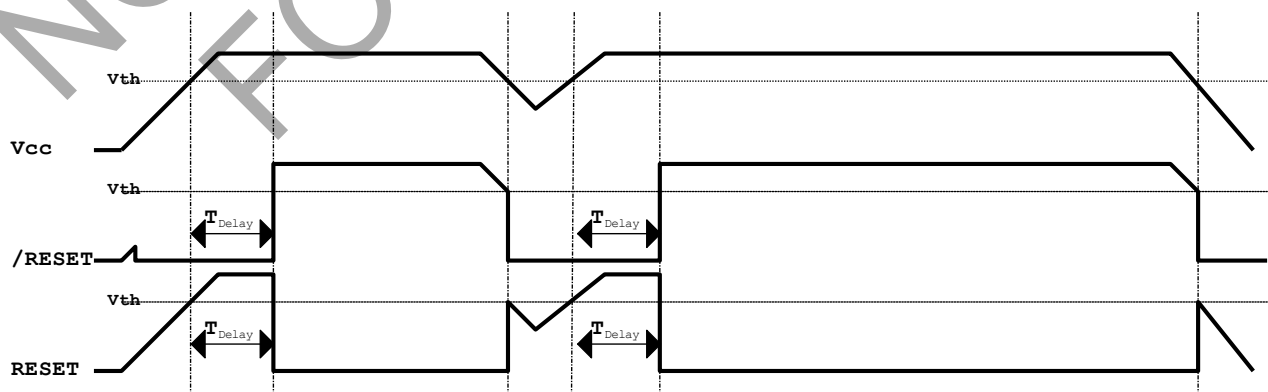
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_{CC}$	$V_{CC}$ Range	$T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$	1.0	—	5.5	V
$I_{CC}$	Supply Current	$V_{TH} + 0.2V$	—	30	40	μA
$V_{TH}$	Reset Threshold	APX809/810-23	2.21	2.25	2.30	V
		APX809/810-26	2.59	2.63	2.69	
		APX809/810-29	2.88	2.93	3.00	
		APX809/810-31	3.02	3.08	3.15	
		APX809/810-40	3.93	4.00	4.08	
		APX809/810-44	4.31	4.38	4.47	
		APX809/810-46	4.56	4.63	4.72	
		APX809/810-23	2.20	2.25	2.30	V
		APX809/810-26	2.57	2.63	2.69	
		APX809/810-29	2.86	2.93	3.00	
		APX809/810-31	3.00	3.08	3.15	
		APX809/810-40	3.92	4.00	4.08	
		APX809/810-44	4.29	4.38	4.47	
		APX809/810-46	4.54	4.63	4.72	
	Reset Threshold Tempco	—	—	30	—	ppm/°C
$t_S$	Set-up Time	$V_{CC} = V_{TH}$ to $(V_{TH} - 100\text{mV})$	—	20	—	μs
$t_{DELAY}$	Reset Active Timeout Period	$T_A = 0^\circ\text{C}$ to $+85^\circ\text{C}$	140	200	280	ms
$V_{OL}$	RESET Output Voltage Low (APX809)	$V_{CC} = V_{TH} - 0.2$ , $I_{SINK} = 1.2\text{mA}$	—	—	0.3	V
		$V_{CC} = V_{TH} - 0.2$ , $I_{SINK} = 3.2\text{mA}$	—	—	0.4	
		$V_{CC} > 1.0V$ , $I_{SINK} = 50\mu\text{A}$	—	—	0.3	
$V_{OH}$	RESET Output Voltage-High (APX809)	$V_{CC} > V_{TH} + 0.2$ , $I_{SOURCE} = 500\mu\text{A}$	$0.8V_{CC}$	—	—	V
		$V_{CC} > V_{TH} + 0.2$ , $I_{SOURCE} = 800\mu\text{A}$	$V_{CC} - 1.5$	—	—	
$V_{OL}$	RESET Output Voltage-Low (APX810)	$V_{CC} = V_{TH} + 0.2$ , $I_{SINK} = 1.2\text{mA}$	—	—	0.3	V
		$V_{CC} = V_{TH} + 0.2$ , $I_{SINK} = 3.2\text{mA}$	—	—	0.4	
$V_{OH}$	RESET Output Voltage-High (APX810)	$1.8V < V_{CC} < V_{TH} - 0.2$ , $I_{SOURCE} = 150\mu\text{A}$	$0.8V_{CC}$	—	—	V
$\theta_{JA}$	Thermal Resistance Junction-to-Ambient	SOT23 (Note 4)	—	201	—	°C/W
$\theta_{JC}$	Thermal Resistance Junction-to-Case	SOT23 (Note 4)	—	56	—	°C/W

Note: 4. Test condition for SOT23: Devices mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

## Performance Characteristics



## Timing Diagram



## Functional Description

A microprocessor's ( $\mu P$ 's) reset input starts the  $\mu P$  in a known state. The APX809/810 assert reset to prevent code-execution errors during power-up, power-down, or brownout conditions. They assert a reset signal whenever the  $V_{CC}$  supply voltage declines below a preset threshold, keeping it asserted for at least 240ms after  $V_{CC}$  has risen above the reset threshold. The APX809/810 have a push-pull output stage.

### Ensuring a Valid Reset Output

#### Down to $V_{CC} = 0$

$\overline{RESET}$  is guaranteed to be a logic low for  $V_{CC} > 1V$ . Once  $V_{CC}$  exceeds the reset threshold, an internal timer keeps  $\overline{RESET}$  low for the reset timeout period; after this interval,  $\overline{RESET}$  goes high. If a brownout condition occurs ( $V_{CC}$  dips below the  $\overline{RESET}$  reset threshold),  $\overline{RESET}$  goes low. Any time  $V_{CC}$  goes below the reset threshold, the internal timer resets to zero, and  $\overline{RESET}$  goes low. The internal timer starts after  $V_{CC}$  returns above the reset threshold, and  $\overline{RESET}$  remains low for the reset timeout period.

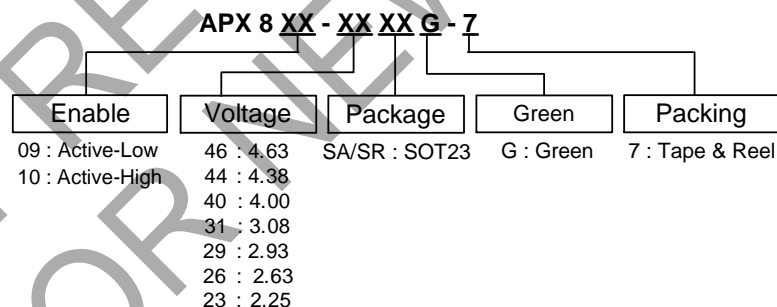
When  $V_{CC}$  falls below 1V, the APX809  $\overline{RESET}$  output no longer sinks current — it becomes an open circuit. Therefore, high-impedance CMOS logic inputs connected to  $\overline{RESET}$  can drift to undetermined voltages.

This presents no problem in most applications since most  $\mu P$  and other circuitry is inoperative with  $V_{CC}$  below 1V. However, in applications where  $\overline{RESET}$  must be valid down to 0V, adding a pull down resistor to  $\overline{RESET}$  causes any stray leakage currents to flow to ground, holding  $\overline{RESET}$  low. R1's value is not critical; 100k are large enough not to load  $\overline{RESET}$  and small enough to pull  $\overline{RESET}$  to ground. For the APX810 if  $\overline{RESET}$  is required to remain valid for  $V_{CC} < 1V$ .

### Benefits of Highly Accurate Reset Threshold

Most  $\mu P$  supervisor ICs has reset threshold voltages between 5% and 10% below the value of nominal supply voltages. This ensures a reset will not occur within 5% of the nominal supply, but will occur when the supply is 10% below nominal. When using ICs rated at only the nominal supply  $\pm 5\%$ , this leaves a zone of uncertainty where the supply is between 5% and 10% low, and where the reset may or may not be asserted.

## Ordering Information



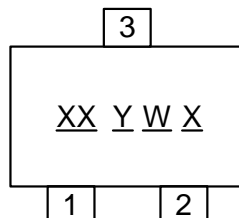
Part Number	Package Code	Packaging (Note 5)	7" Tape and Reel	
			Quantity	Part Number Suffix
APX809-XXSAG-7	SA	SOT23	3000/Tape & Reel	-7
APX810-XXSAG-7	SA	SOT23	3000/Tape & Reel	-7
APX809-XXSRG-7	SR	SOT23	3000/Tape & Reel	-7
APX810-XXSRG-7	SR	SOT23	3000/Tape & Reel	-7

Note: 5. Pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at <http://www.diodes.com/package-outlines.html>.

## Marking Information

(1) SOT23

( Top View )



XX : Identification code

Y : Year 0~9

W : Week : A~Z : 1~26 week;  
a~z : 27~52 week; z represents  
52 and 53 week

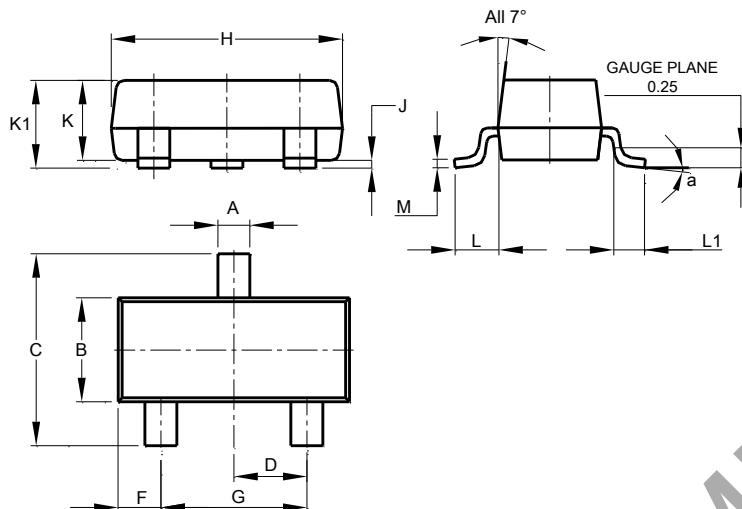
X : A~Z : Green

Device	Package	Identification Code
APX809-46SA	SOT23	X2
APX809-44SA	SOT23	X3
APX809-40SA	SOT23	X4
APX809-31SA	SOT23	X5
APX809-29SA	SOT23	X6
APX809-26SA	SOT23	X7
APX809-23SA	SOT23	X8
APX810-46SA	SOT23	XA
APX810-44SA	SOT23	XB
APX810-40SA	SOT23	XC
APX810-31SA	SOT23	XD
APX810-29SA	SOT23	XE
APX810-26SA	SOT23	XF
APX810-23SA	SOT23	XG
APX809-46SR	SOT23	Y2
APX809-44SR	SOT23	Y3
APX809-40SR	SOT23	Y4
APX809-31SR	SOT23	Y5
APX809-29SR	SOT23	Y6
APX809-26SR	SOT23	Y7
APX809-23SR	SOT23	Y8
APX810-46SR	SOT23	YA
APX810-44SR	SOT23	YB
APX810-40SR	SOT23	YC
APX810-31SR	SOT23	YD
APX810-29SR	SOT23	YE
APX810-26SR	SOT23	YF
APX810-23SR	SOT23	YG

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT23**

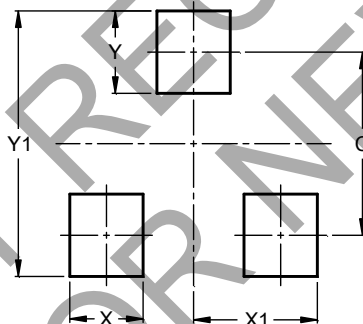


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT23**



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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